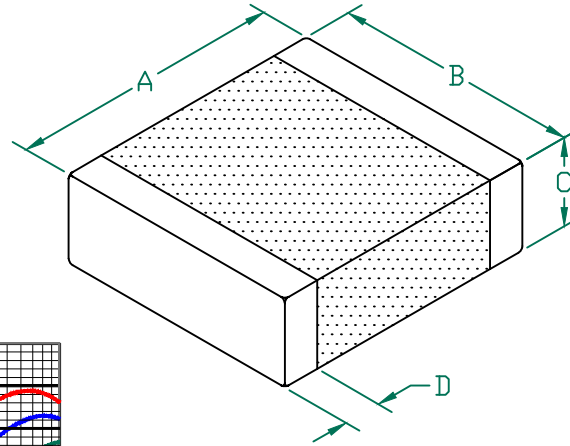


HI2220T101R-10

PHYSICAL DIMENSIONS:

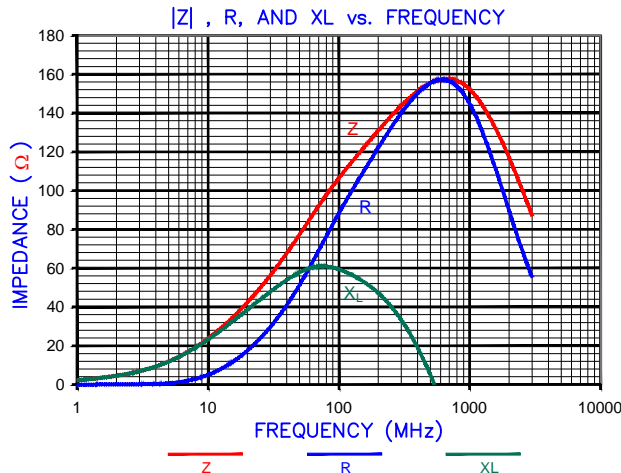
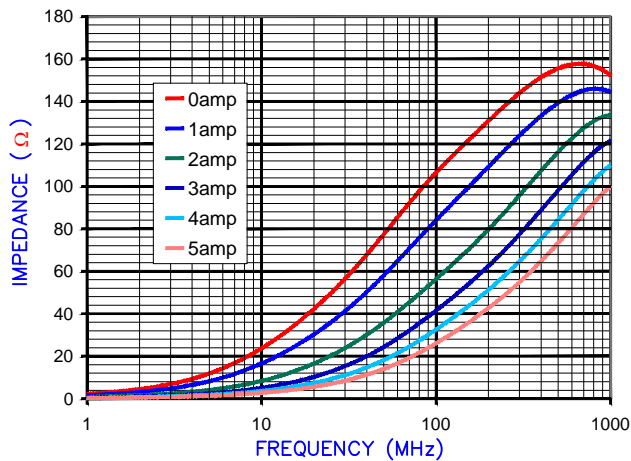
A	5.59 [.220]	+ 0.51 [.020]
B	5.08 [.200]	+ 0.25 [.010]
C	1.80 [.071]	+ 0.25 [.010]
D	0.76 [.030]	+ 0.25 [.010]



ELECTRICAL CHARACTERISTICS:

Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	100	
Minimum	75	
Maximum	125	0.006
		6000 mA

Z vs. FREQUENCY
IMPEDANCE UNDER DC BIAS

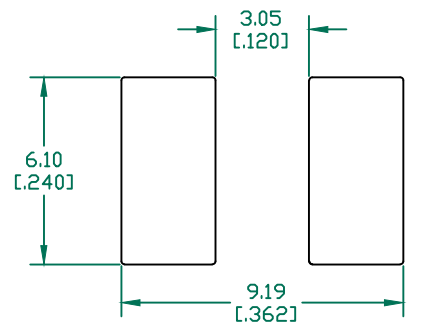


AGILENT E4991A RF Impedance/Material Analyzer
HP 16092A Test Fixture. TEST REF. 3185

NOTES: UNLESS OTHERWISE SPECIFIED

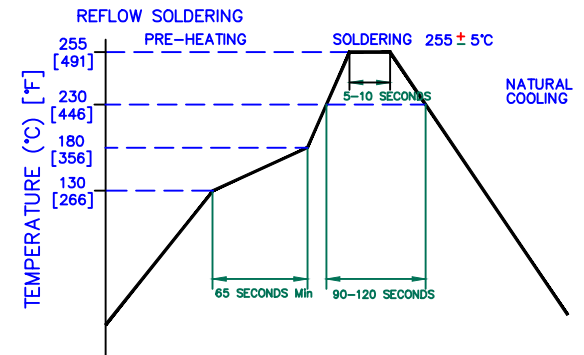
1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2,000 PCS/REEL.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATEING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird Technologies and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Technologies. All rights to design or invention are reserved.			
PROJECT/PART NUMBER:				REV C PART TYPE: CO-FIRE DRAWN BY: TMB			
C ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE 08/05/13 QU				HI2220T101R-10			
B UPDATE COMPANY LOGO ADD ROHS SYMBOL 02/14/08 JRK				DATE: 04/03/04 SCALE: NTS SHEET: 1 of 1			
A ORIGINAL DRAFT 04/03/04 TMB				CAD # TOOL #			
REV DESCRIPTION				DATE INT HI2220T101R-10-C			